Rev. 6-93)	8-10-1999 ET U.S. DEPARTMENT OF COMMERCE Patent and Trademark Office
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Additional names of conveying parties attached?Yes	<u>X</u> No
3. Nature of conveyance: <u>X</u> Assignment Merger	Street Address: 8000 SOUTH FEDERAL WAY
Security Agreement Change of Na	City: <u>BOISE</u> State <u>ID</u>
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Execution Dates: 1) <u>JULY 28, 1999</u> 2) 5) 3) 6)	Additional names & addresses attached?Yes _XNo
A. Patent Application No(s).	B. Patent No(
	MRD 7.30.99
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5. Name and address of party to whom correspondence concerning document should be mailed: 9/1999 TBADE1 00000039 09363399	The second se
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## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:	)
	) Docket No.: 660073.773
Tongbi Jiang	) Disclosure Number: 98-1203
	)
Filed: Concurrently herewith	)
	)
For: APPARATUS AND METHODS	)
OF REINFORCEMENT OF	)
LEAD BONDING IN	)
MICROELECTRONICS PACKAGES	)
	)

## ASSIGNMENT:

<u>X</u>	Enclosed for recording
	Previously recorded
Date:	
Reel:	

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FOR GOOD AND VALUABLE CONSIDERATION, the receipt, sufficiency and adequacy of which are hereby acknowledged, the undersigned does hereby:

SELL, ASSIGN AND TRANSFER to Micron Technology, Inc. (the "Assignee"), a corporation of Delaware, having a place of business at 8000 South Federal Way, Boise, Idaho 83706-9632, the entire right, title and interest for the United States and all foreign countries, in and to any and all improvements which are disclosed in the application for United States Letters Patent, which has been executed by the undersigned concurrently herewith and is entitled "APPARATUS AND METHODS OF REINFORCEMENT OF LEAD BONDING IN MICROELECTRONICS PACKAGES"; such application and all divisional, continuing, substitute, renewal, reissue and all other applications for patent which have been or shall be filed in the United States and all foreign countries on any of such improvements; all original and reissued patents which have been or shall be issued in the United States and all foreign applications under the provisions of any convention or treaty and claim priority based on such application in the United States of America;

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AUTHORIZE AND REQUEST the issuing authority to issue any and all United States and foreign patents granted on such improvements to the Assignee;

WARRANT AND COVENANT that no assignment, grant, mortgage, license or other agreement affecting the rights and property herein conveyed has been or will be made to others by the undersigned, and that the full right to convey the same as herein expressed is possessed by the undersigned;

COVENANT that, when requested and at the expense of the Assignee, to carry out in good faith the intent and purpose of this assignment, the undersigned will execute all divisional, continuing, substitute, renewal, reissue, and all other patent applications on any and all such improvements; execute all rightful oaths, declarations, assignments, powers of attorney and other papers; communicate to the Assignee all facts known to the undersigned relating to such improvements and the history thereof; and generally do everything possible which the Assignee shall consider desirable for securing, maintaining and enforcing proper patent protection for such improvements and for vesting title to such improvements in the Assignee;

TO BE BINDING on the heirs, assigns, representatives and successors of the undersigned and extend to the successors, assigns and nominees of the Assignee.

Date: 7/28/99

Tongbi Jiang

STATE OF IDAHO) ) ss. County of <u>(lda)</u>

BEFORE ME, this <u>2</u><sup>44</sup> day of <u>July</u>, 19<u>9</u>, personally appeared the above-named individual, to me known to be the person who is described in and who executed the foregoing assignment instrument and acknowledged to me that he executed the same of his own free will for the purpose the foregoing assignment instrument and

Notary or Consular Officer My Commission Expires 3-26-23

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Page 2 of 2

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**RECORDED: 07/30/1999**